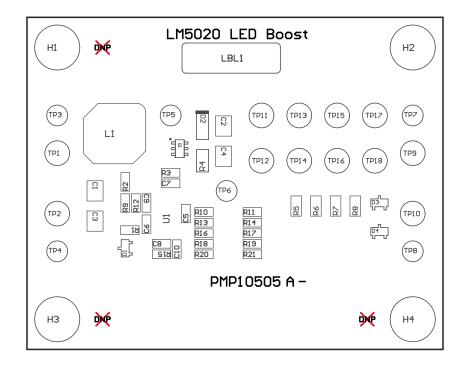
ZZ1 Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

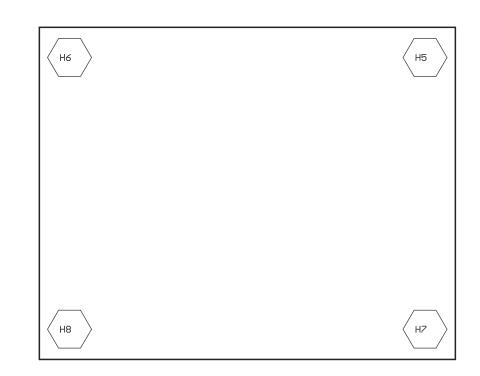


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM TOP SIDE | BOARD #: PMP10505 | REV: A | SVN REV | : Not In VersionControl |
|----------------------------------|--------------------|--------------|---------|-------------------------|
| IGNORE -> Top Overlay | | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 7/11/2 | :014 2:06:42 | PM | TEXAS INSTRUMENTS |

| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP10505 | REV: A | SVN REV: | : Not In VersionControl |
|-------------------------------------|--------------------------|-------------|----------|-------------------------|
| | Bottom Overlay <- 390001 | | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 7/11/2 | 014 2:06:43 | PM | TEXAS INSTRUMENTS |

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001



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